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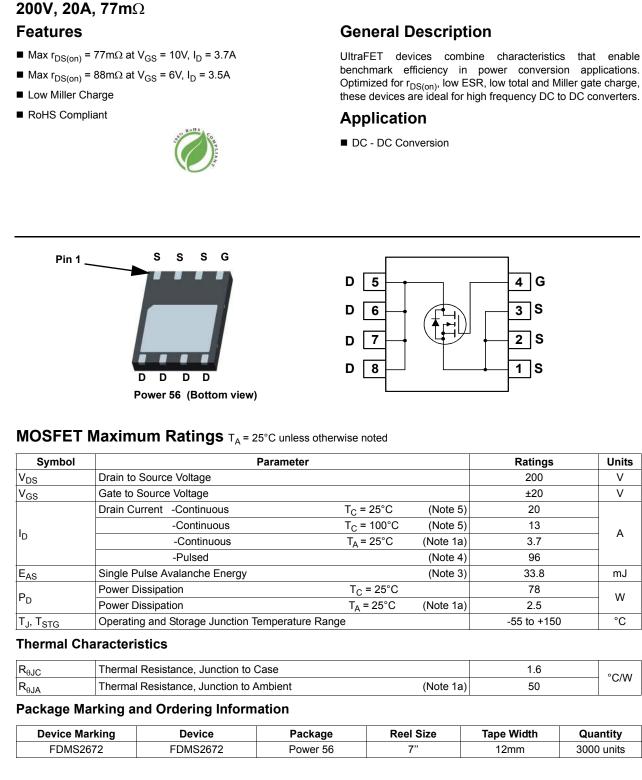


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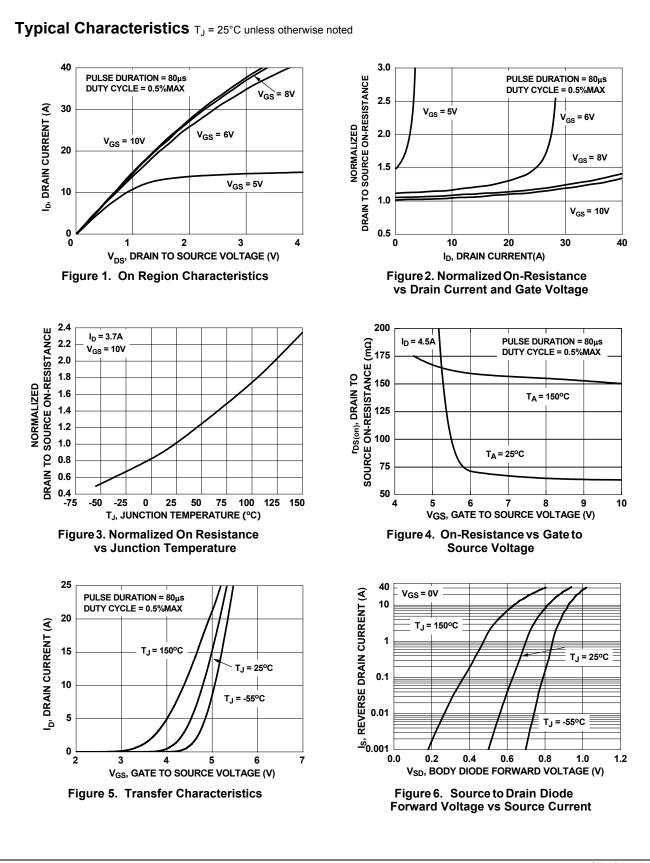
FAIRCHILD

**FDMS2672** 

**N-Channel UltraFET Trench MOSFET** 

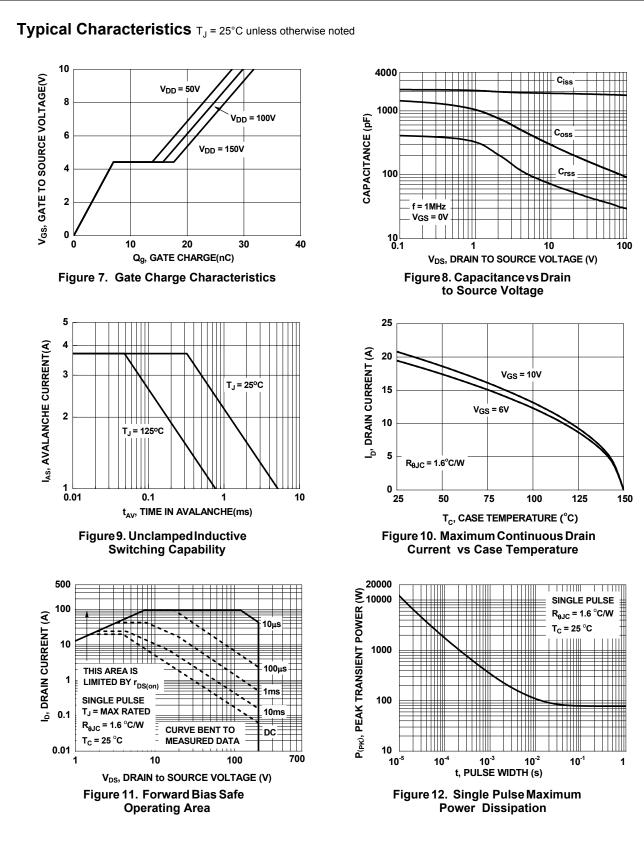
eristics rain to Source Breakdown Voltage reakdown Voltage Temperature perficient ero Gate Voltage Drain Current	$I_D = 250 \mu A, V_{GS} = 0V$ $I_D = 250 \mu A,$ referenced to 25°C	200	210		V
rain to Source Breakdown Voltage reakdown Voltage Temperature pefficient ero Gate Voltage Drain Current	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$	200	210		-
reakdown Voltage Temperature pefficient ero Gate Voltage Drain Current	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		210		-
ero Gate Voltage Drain Current	14 40014				mV/°C
-	V <sub>DS</sub> = 160V			1	μA
ate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
eristics					
	$V_{aa} = V_{aa}$ $I_a = 250 \mu A$	2	3.1	4	V
ate to Source Threshold Voltage	$I_D = 250 \mu A$ , referenced to 25°C	-	-10		mV/°C
	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.7A		64	77	
Drain to Source On Resistance	$V_{GS} = 6V, I_D = 3.5A$		69	88	mΩ
	$V_{GS} = 10V, I_D = 3.7A T_J = 125^{\circ}C$		129	156	
prward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 3.7A		14		S
aracteristics					
			1740	2315	рF
· · · · · · · · · · · · · · · · · · ·	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V, f = 1MHz		95	125	pF
everse Transfer Capacitance			30	45	pF
ate Resistance	-	0.1	1	5	Ω
haracteristics					
urn-On Delay Time	$V_{DD} = 100V, I_D = 3.7A$		22	34	ns
se Time			11	22	ns
urn-Off Delay Time			36	57	ns
all Time			10	20	ns
otal Gate Charge at 10V	$V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 100V$		30	42	nC
-	I <sub>D</sub> = 3.7A		7		nC
ate to Drain "Miller" Charge			8		nC
e Diode Characteristics					
ource to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 3.7A$ (Note 2)		0.8	1.2	V
everse Recovery Time	$I_{r} = 3.74$ di/dt = 1004/us		70	105	ns
everse Recovery Charge	1μ = 3.7Α, αναι = 10074μ3		238	357	nC
	ate to Source Threshold Voltage mperature Coefficient ain to Source On Resistance onward Transconductance aracteristics out Capacitance utput Capacitance everse Transfer Capacitance ate Resistance haracteristics mn-On Delay Time se Time um-Off Delay Time tal Gate Charge at 10V ate to Source Gate Charge ate to Drain "Miller" Charge e Diode Characteristics ource to Drain Diode Forward Voltage everse Recovery Time everse Recovery Charge	ate to Source Threshold Voltage mperature Coefficient $V_{GS} = V_{DS}$ , $I_D = 250\mu A$ $I_D = 250\mu A$ , referenced to $25^{\circ}C$ ain to Source On Resistance $V_{GS} = 10V$ , $I_D = 3.7A$ $V_{GS} = 6V$ , $I_D = 3.5A$ $V_{GS} = 10V$ , $I_D = 3.7A$ TJ = $125^{\circ}C$ prward Transconductance $V_{DS} = 10V$ , $I_D = 3.7A$ TJ = $125^{\circ}C$ prward Transconductance $V_{DS} = 10V$ , $I_D = 3.7A$ present Capacitance ate Resistance $V_{DS} = 100V$ , $V_{GS} = 0V$ , f = $1MHz$ provide Capacitance ate Resistance $V_{DD} = 100V$ , $I_D = 3.7A$ $V_{GS} = 10V$ , $R_{GEN} = 6\Omega$ provide to Delay Time ate to Source Gate Charge ate to Drain "Miller" Charge $V_{GS} = 0V$ to $10V$ $I_D = 3.7A$ $I_D = 3.7A$ prove to Drain Diode Forward Voltage averse Recovery Time averse Recovery Charge $V_{GS} = 0V$ , $I_S = 3.7A$ (Note 2) $I_F = 3.7A$ , di/dt = $100A/\mu s$	ate to Source Threshold Voltage mperature Coefficient $V_{GS} = V_{DS}$ , $I_D = 250\muA$ 2ate to Source Threshold Voltage mperature Coefficient $I_D = 250\muA$ , referenced to $25^\circ$ C $I_D = 250\muA$ , referenced to $25^\circ$ Cain to Source On Resistance $V_{GS} = 10V$ , $I_D = 3.7A$ $V_{GS} = 6V$ , $I_D = 3.5A$ $V_{GS} = 10V$ , $I_D = 3.7A$ aracteristics $V_{DS} = 10V$ , $I_D = 3.7A$ $V_{GS} = 10V$ , $I_D = 3.7A$ $V_{GS} = 10V$ , $I_D = 3.7A$ aracteristics $V_{DS} = 10V$ , $I_D = 3.7A$ $V_{SS} = 0V$ , f = 1MHz $I_{DS} = 100V$ , $V_{GS} = 0V$ , f = 1MHzate Resistance $V_{DS} = 100V$ , $V_{GS} = 0V$ , f = 1MHz $I_{DD} = 100V$ , $I_D = 3.7A$ but Capacitance sverse Transfer Capacitance ate Resistance $V_{DD} = 100V$ , $I_D = 3.7A$ $V_{DD} = 100V$ , $I_D = 3.7A$ $V_{GS} = 10V$ , $R_{GEN} = 6\Omega$ III Time tal Gate Charge at $10V$ $V_{GS} = 0V$ to $10V$ $V_{DD} = 100V$ $I_D = 3.7A$ ate to Drain "Miller" Charge $V_{GS} = 0V$ to $10V$ $V_{DD} = 100V$ $I_D = 3.7A$ <b>b Diode Characteristics</b> $V_{GS} = 0V$ , $I_S = 3.7A$ (Note 2) everse Recovery Time everse Recovery Charge $V_{GS} = 0V$ , $I_S = 3.7A$ (Note 2)	ate to Source Threshold Voltage mperature Coefficient $V_{GS} = V_{DS}$ , $I_D = 250\mu$ A, referenced to 25°C23.1ate to Source Threshold Voltage mperature Coefficient $I_D = 250\mu$ A, referenced to 25°C-10ain to Source On Resistance $V_{GS} = 10V$ , $I_D = 3.7A$ 64 $V_{GS} = 10V$ , $I_D = 3.7A$ 64 $V_{GS} = 10V$ , $I_D = 3.7A$ 64 $V_{GS} = 10V$ , $I_D = 3.7A$ 64aracteristics $V_{DS} = 10V$ , $I_D = 3.7A$ 14aracteristics $V_{DS} = 10V$ , $I_D = 3.7A$ 14aracteristics $V_{DS} = 10V$ , $V_{GS} = 0V$ , f = 1MHz1740 $P_{DS} = 10V, V_{GS} = 0V, f = 10Hz$ 95sverse Transfer Capacitance ate Resistance0.11haracteristics0.11intro-On Delay Time se Time $V_{DD} = 100V, I_D = 3.7A$ 22 $P_{CS} = 10V, V_{GS} = 0V to 10V, V_{GS} = 6\Omega$ 36 $III Time$ 1030tate to Source Gate Charge ate to Source Gate Charge $I_D = 3.7A$ 7ate to Drain "Miller" Charge8e Diode Characteristics8e Diode Characteristics $V_{GS} = 0V, I_S = 3.7A$ (Note 2)0.8everse Recovery Time everse Recovery Charge $V_{GS} = 0V, I_S = 3.7A$ (i/dt = 100A/ $\mu$ s238	tate to Source Threshold Voltage $V_{GS} = V_{DS}$ , $I_D = 250 \mu A$ 2   3.1   4     ate to Source Threshold Voltage $I_D = 250 \mu A$ , referenced to $25^{\circ}C$ -10   -10     mean to Source On Resistance $V_{GS} = 10V$ , $I_D = 3.7A$ 64   77     vis of the second condition of the second conditis the second condition of the second condition of th

Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.</li>
E<sub>AS</sub> of 33.8mJ is based on starting T<sub>J</sub> = 25 C, L = 3mH, I<sub>AS</sub> = 4.75A, V<sub>DD</sub> = 25V, V<sub>GS</sub> = 10V.
Pulsed Id please refer to Fig 11 SOA graph for more details.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

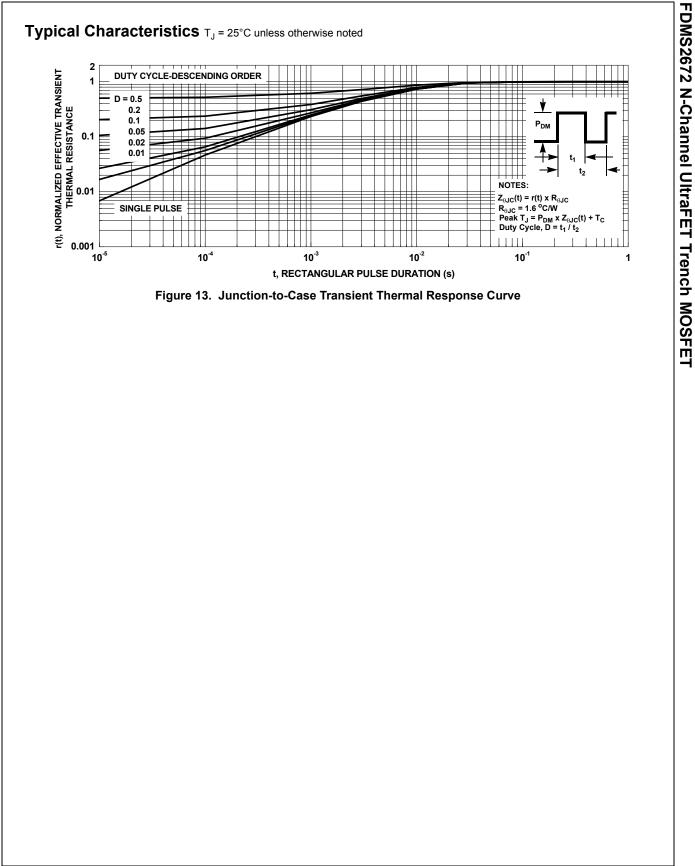


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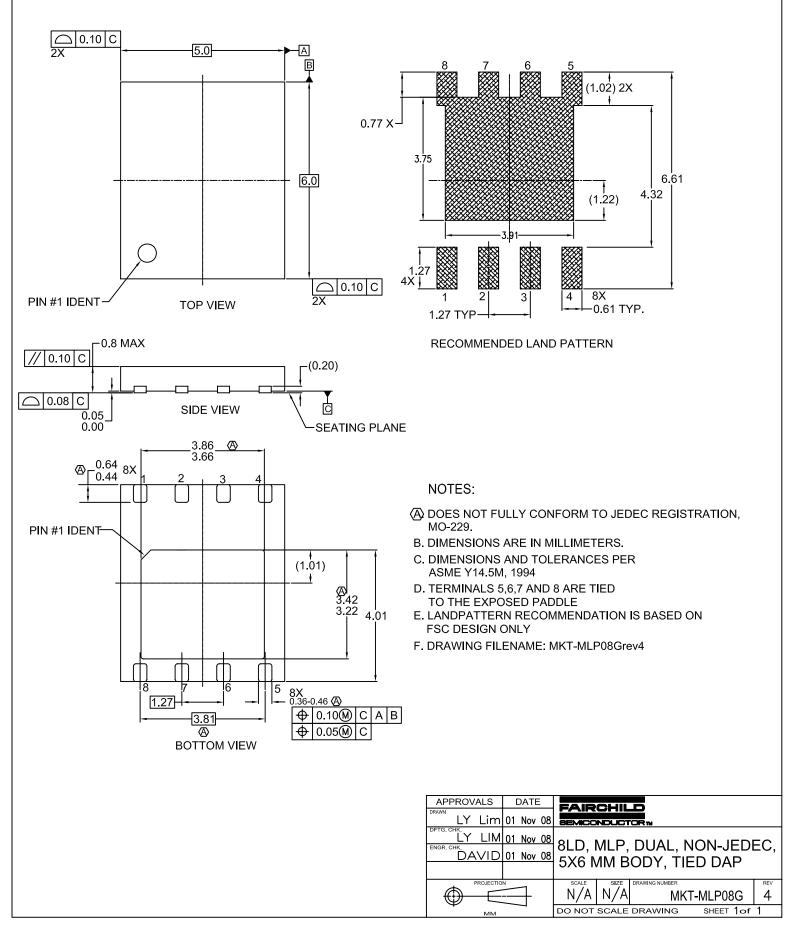




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	REVISIONS		
NBR	DESCRIPTION	DATE	NAME/SITE
1	RELEASE TO DOCUMENT CONTROL	090305	David/FSPM
2	REVISE TO CORRECT DAP SIZE	080605	David/FSPM
3	I) REVISE TO CORRECT PKG THK		
	II) REVISE THE PKG PROFILE TOLERANCE	210306	CK/FSPM
4	ADD IN LEAD LENGTH FOR LAND PATTERN	220908	LY/FSPM



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